

Comparison of nBn and nBp mid-wave barrier infrared photodetectors

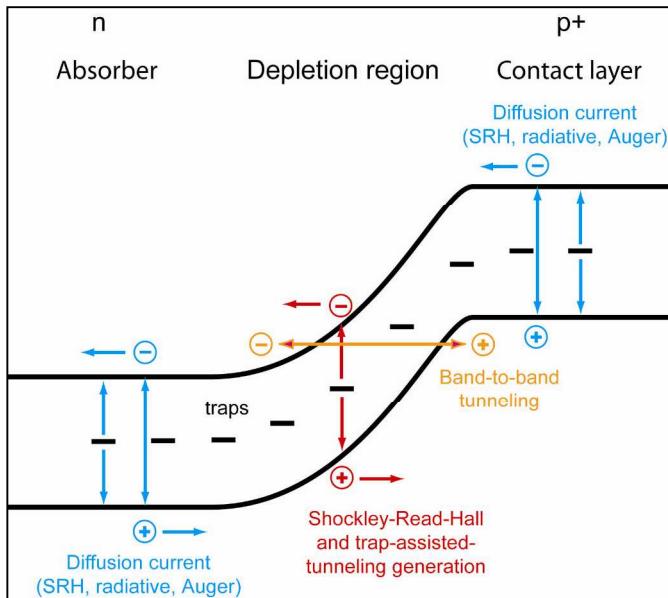
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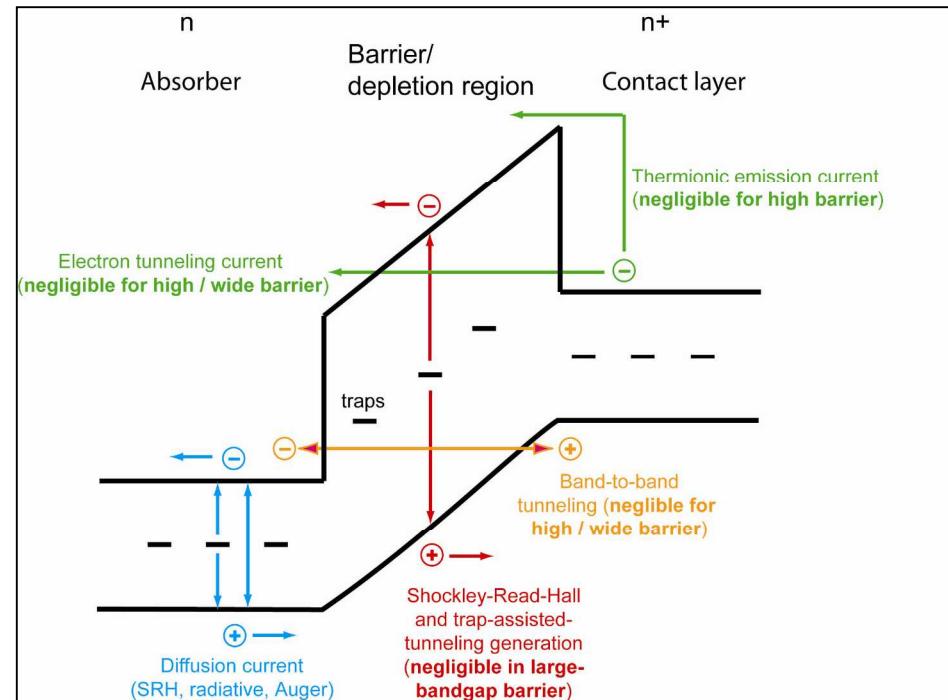
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Intrinsic dark current sources in p-n and nBn detectors

Conventional p-n homojunction



Idealized nBn structure



- Idealized nBn structure eliminates dark current from all sources except generation processes that produce absorber diffusion current
- Elimination of depletion region SRH generation may greatly reduce dark current at lower temperatures (where depletion region SRH dominates in conventional p-n)

Why examine nBp structures?

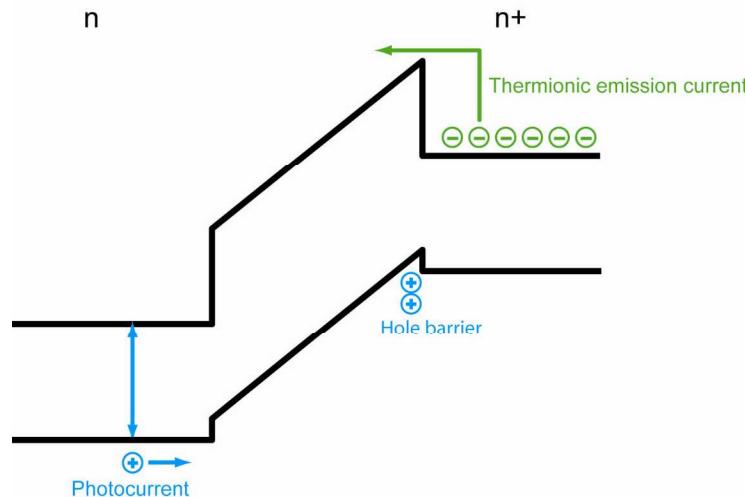
nBn structure relies on a very special case with zero VB discontinuity and large CB discontinuity between absorber and barrier. In more general case:

- VB discontinuity produces undesirable hole barrier, or
- Smaller CB discontinuity (or high temperature) results in electron thermionic emission current

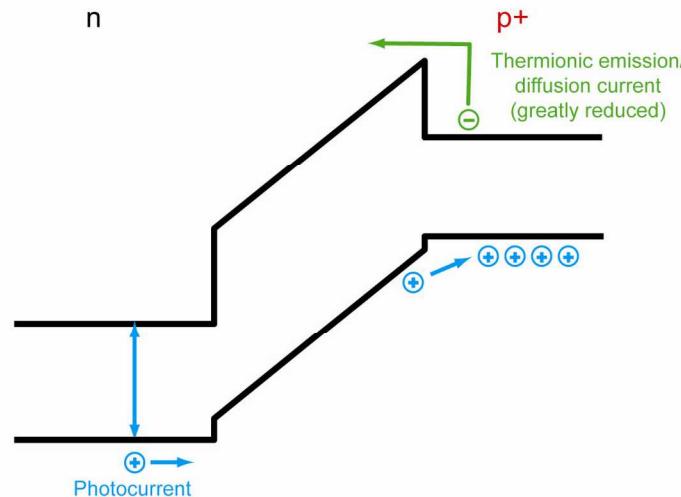
nBp structure allows substantially greater flexibility in material choices

- p contact material need not be same as absorber
- p doping reduces thermionic emission dark current
- Also exhibits high responsivity at zero bias

a poor nBn



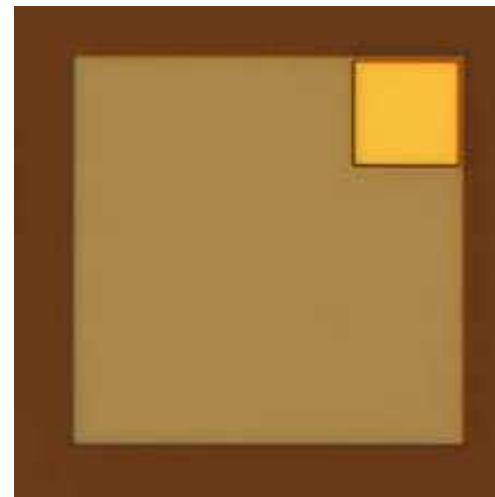
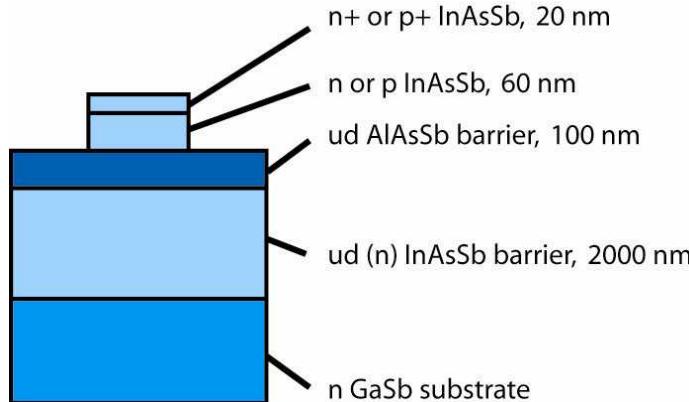
nBp





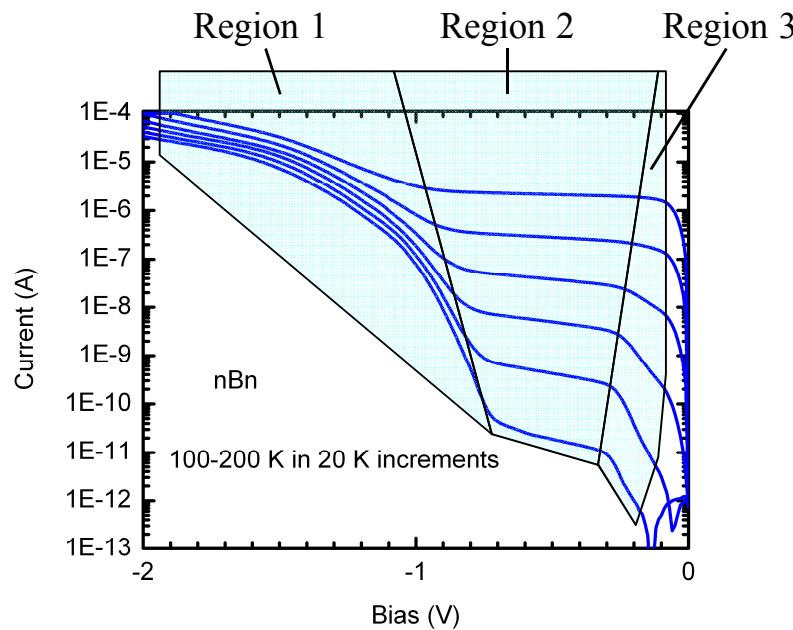
Goals and Methods

- Examine and compare characteristics of similar mid-wave nBn and nBp devices
 - Devices nominally identical except for doping of contact layer
- Perform numerical simulation to understand nBn and nBp performance
- Extract material properties relevant to device performance
- Experimental comparison limited to unoptimized structures
 - Changes to structures will significantly alter this comparison*
- Device structure
 - Absorber InAsSb nearly lattice-matched to GaSb, not intentionally doped
 - Barrier AlAsSb nearly lattice-matched to GaSb, not intentionally doped
 - Contact layer InAsSb, either Si-doped (nBn) or Be-doped (nBp)
 - Absorber bandgap $\sim 4.2 \mu\text{m}$ (at 200 K)
 - Large-area devices ($500 \times 500 \mu\text{m}^2$)

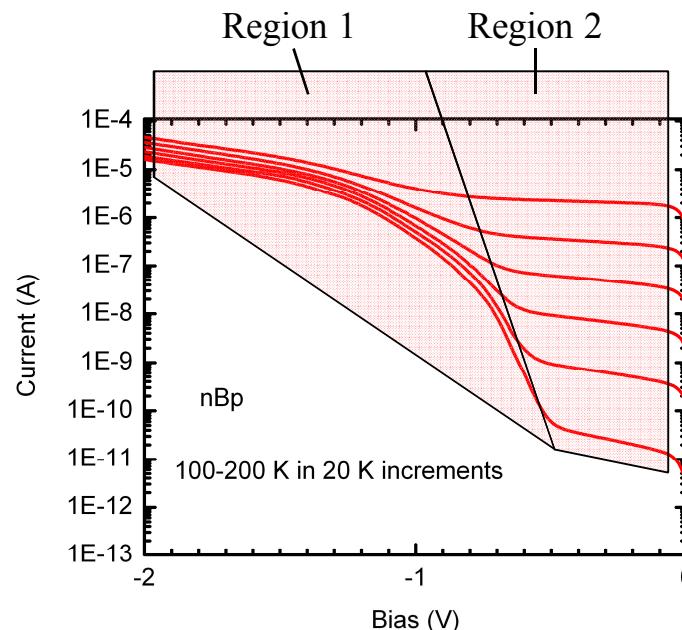


Detector dark I-V characteristics

nBn



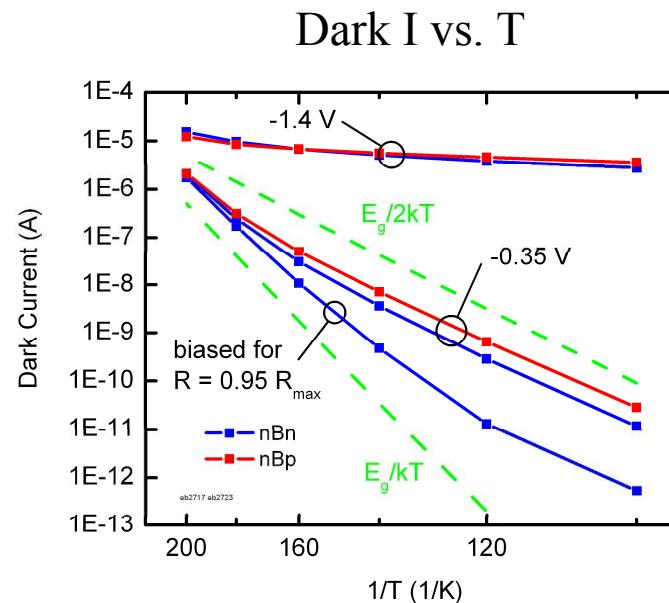
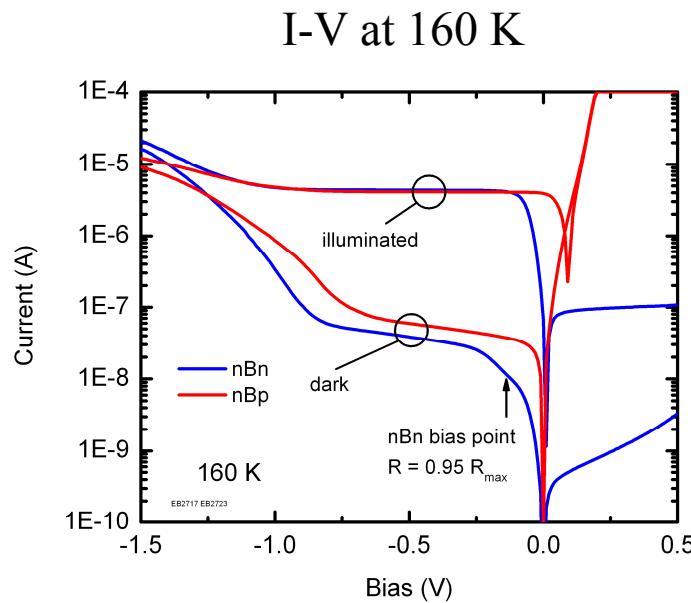
nBp



Region	T dependence	Bias dependence
1	weak	strong
2	strong	weak
3	strong	strong

- nBn has nonzero I at zero bias (low T)
absence in nBp suggests e- trapping
- nBp has no Region 3

Comparison of dark and illuminated I-Vs

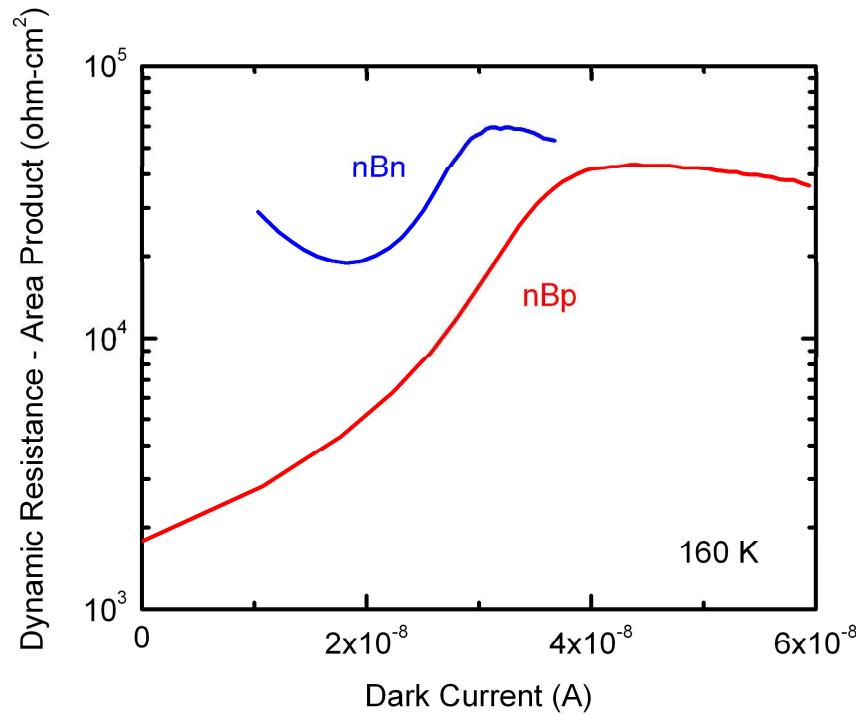


$E_g/2kT$ means $\sim T^{3/2} \exp(-E_g(T)/2kT)$

- nBp lacks Region 3 (“shoulder”)
- Similar maximum responsivities
- nBn requires significant bias for max responsivity
- nBn dark currents generally slightly less than nBp
- nBn achieves max responsivity in shoulder region

- Region 1 has little temperature dependence
→ tunneling
- Region 2 has $E_g/2kT$ dependence
→ depletion region Shockley-Read-Hall
- nBn biased at $0.95 R_{\max}$ has E_g/kT dependence
→ diffusion current

Comparison of dynamic resistance



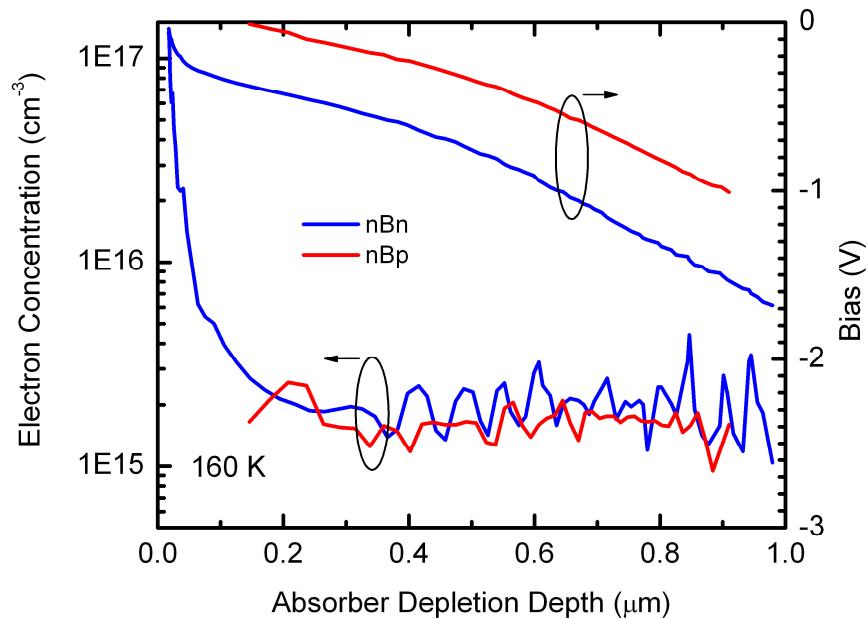
Shown only for biases with responsivity $\geq 95\%$ of maximum responsivity
For any given dark current, nBn has higher dynamic resistance

- Suggests that lower dark current of nBp at low bias offset by higher Johnson noise

Capacitance-voltage measurements

$$C = \frac{c_{abs}c_{bar}}{c_{abs} + c_{bar}} \quad n = -\frac{2}{A^2 q \epsilon_0 \epsilon_{abs}} \frac{dV}{d(\frac{1}{c^2})}$$

- InAsSb absorber is n-type $\sim 2 \times 10^{15} \text{ cm}^{-3}$
- Zero-bias absorber depletion depths
 - nBn $\sim 0 \mu\text{m}$ – **accumulation** layer
 - nBp $0.15 \mu\text{m}$ – large built-in potential
- Absorber depletion depths with bias -0.35 V
 - nBn $0.11 \mu\text{m}$
 - nBp $0.51 \mu\text{m}$



- nBn electron accumulation layer is depleted with bias $\sim 0.3 \text{ V}$
Coincides with boundary between I-V regions 2 and 3
Suggests reduction of dark current in Region 3 related to existence of accumulation layer
- Existence of accumulation layer implies absence of depletion region SRH generation
- nBp has no accumulation layer because of larger built-in potential
nBp will have significant depletion region SRH at any reverse bias



Finite element numerical analysis

- Commercial device simulator with temperature-dependent material parameters
- Drift-diffusion approximation, with thermionic barrier boundary conditions at higher T
- Generation/recombination mechanisms in absorber
 - Radiative
 - Shockley-Read-Hall
 - Trap-assisted tunneling (electric field enhancement to SRH)
 - Auger
- Generation/recombination assumed negligible in barrier
- Absorber/barrier VB discontinuity assumed to be zero
- Strain and quantum confinement effects ignored
- Doping as intended or as measured by C-V. Barrier assumed n-type $4 \times 10^{15} \text{ cm}^{-3}$
- InAsSb SRH lifetime assumed to be 500 ns
- Contact minority carrier generation suppressed by including additional barriers
- Simulation restricted to $|\text{bias}| < 0.6 \text{ V}$



Approximate expressions for dark current generation rates

In **neutral absorber**, where holes are strongly extracted by reverse bias

$$(np \ll n_i^2, \text{ and } n \gg n_i)$$

$$G_{SRH} = \frac{n_i^2}{\tau_p n} \quad (\text{SRH})$$

$$G_{Rad} = C_R n_i^2 \quad (\text{Radiative})$$

$$G_{Aug} = C_n n_i^2 n \quad (\text{Auger})$$

In **absorber depletion region**, where both holes and electrons are extracted

$$(n \ll n_i \text{ and } p \ll n_i)$$

$$G_{SRH} = \frac{n_i}{\tau_p + \tau_n} \quad (\text{SRH})$$

$$G_{Rad} = C_R n_i^2 \quad (\text{Radiative})$$

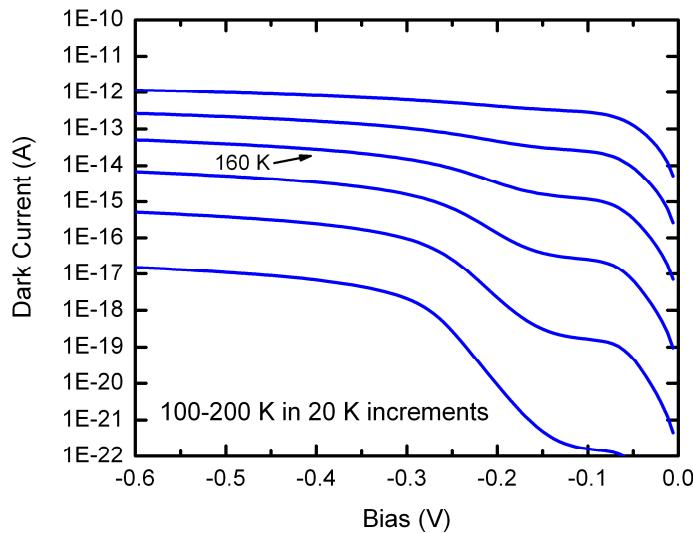
$$G_{Aug} = 0 \quad (\text{Auger})$$

SRH (either in neutral absorber or depletion region)
dominates generation in these devices from 100-200 K

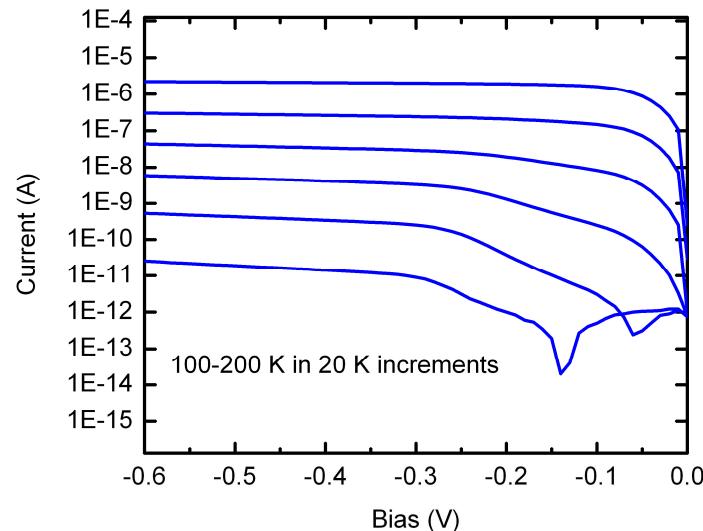
$$\frac{SRH_{depl}}{SRH_{neut}} \sim \frac{N_{abs}}{n_i} \frac{D_{depl}}{D_{neut}} \frac{\tau_p}{(\tau_p + \tau_n)}$$

Comparison of simulated and measured nBn characteristics

Simulated ($1 \times 0.2 \mu\text{m}^2$ device)



Measured ($500 \times 500 \mu\text{m}^2$ device)

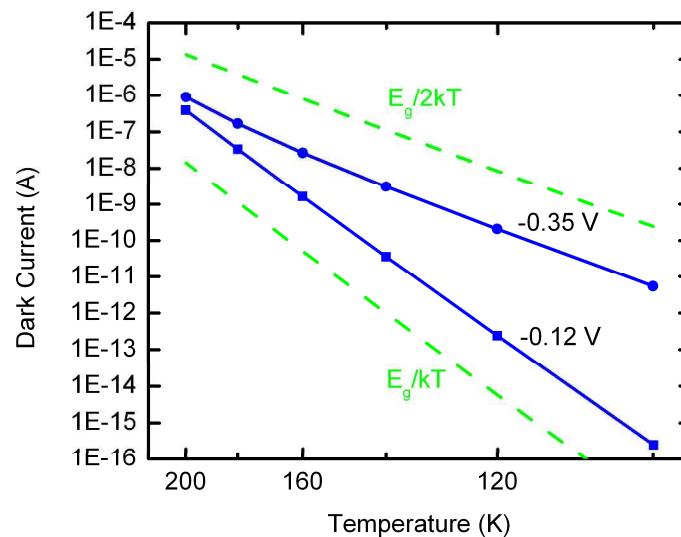
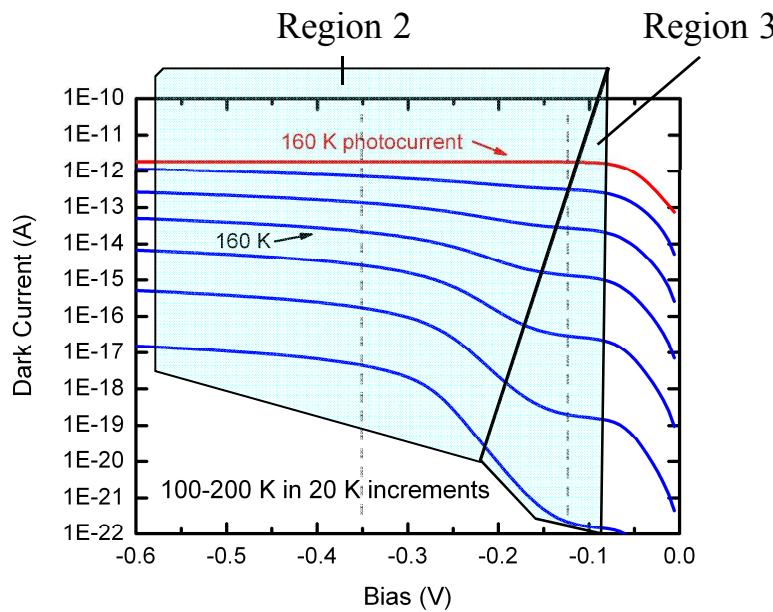


Differences between simulation and experiment may be due to

- Uncertainty in barrier doping and traps
- Residual absorber/barrier VB discontinuity
- Measurement current floor
- Uncertainty in Auger and radiative coefficients (higher T)
- Temperature-dependent SRH lifetime

Depletion region SRH current implies SRH lifetime 600 ns

Simulated nBn dark current



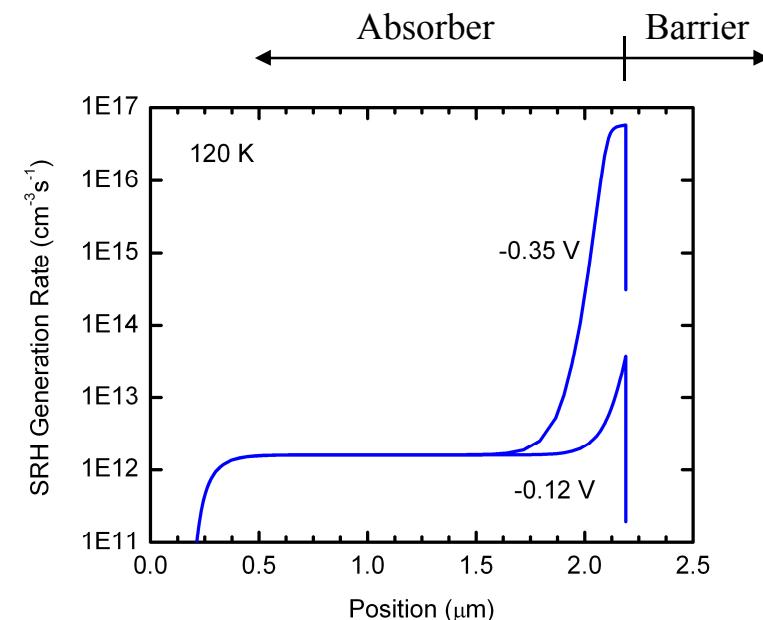
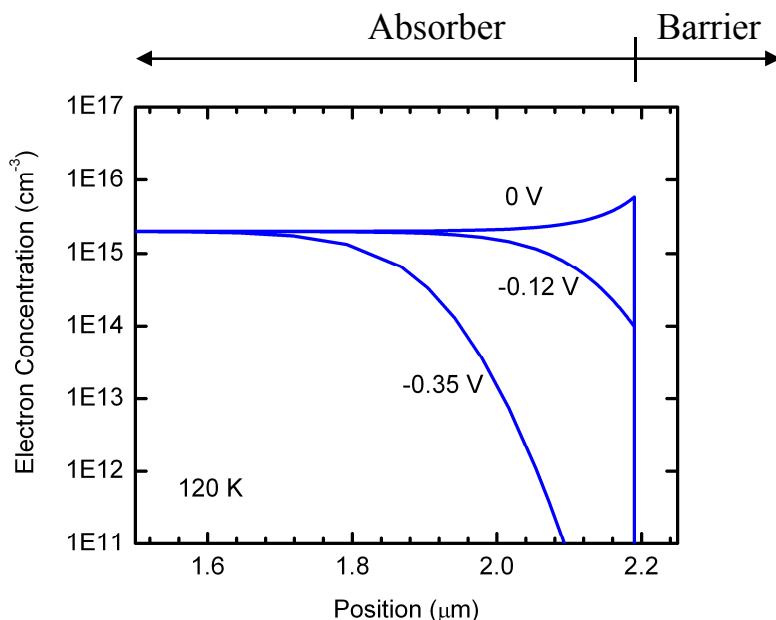
Full responsivity is achieved in Region 3

Current plateaus in Region 3, in contrast to high slope in experiment

As in experimental devices, T dependence of dark current is bias-dependent

- Suggests that depletion-region SRH dominates at -0.35 V (Region 2)
- Neutral absorber SRH (diffusion current) dominates at -0.12 V (Region 3)

Spatial and bias dependence of nBn SRH generation rates



- Absorber accumulation layer exists at 0 bias
- Weak, thin depletion layer at -0.12 V
- Full, thin depletion layer at -0.35 V

- Depletion region SRH weak at -0.12 V
- Depletion region SRH rate saturates near -0.35 V

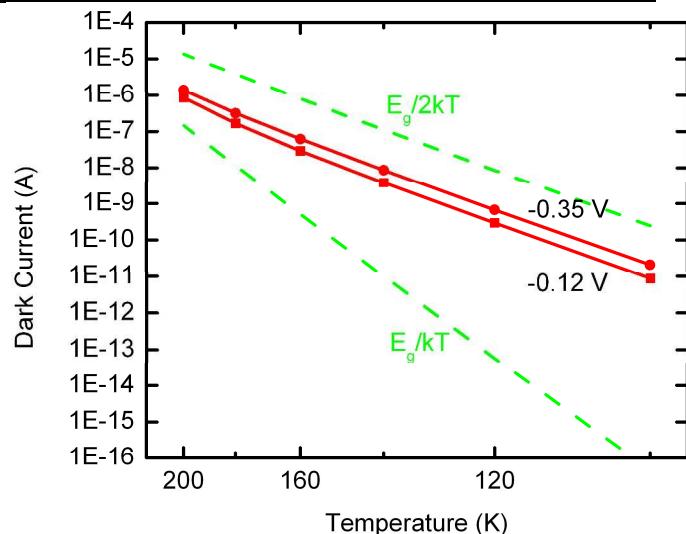
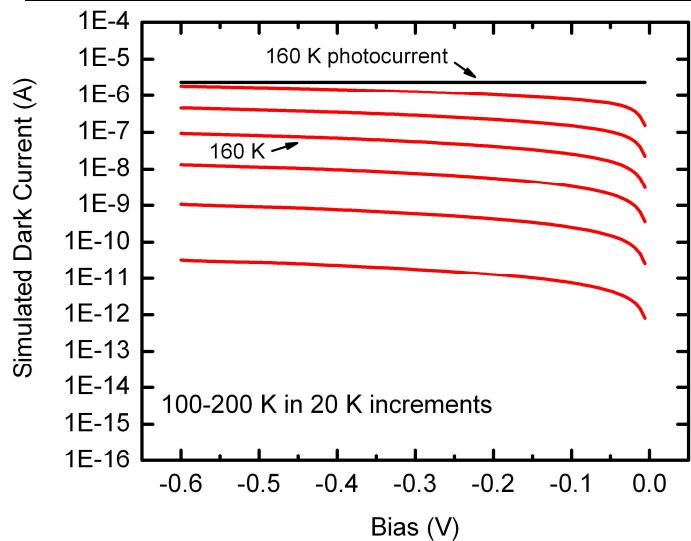
At bias of -0.12 V, which allows photocurrent collection, absorber has only weak depletion region

- Dark current generation dominated by SRH (diffusion current) in neutral absorber region

At bias of -0.35 V, a strong depletion region is formed

- Depletion region SRH dominates

Simulated nBp dark current



Responsivity is flat across entire reverse bias range

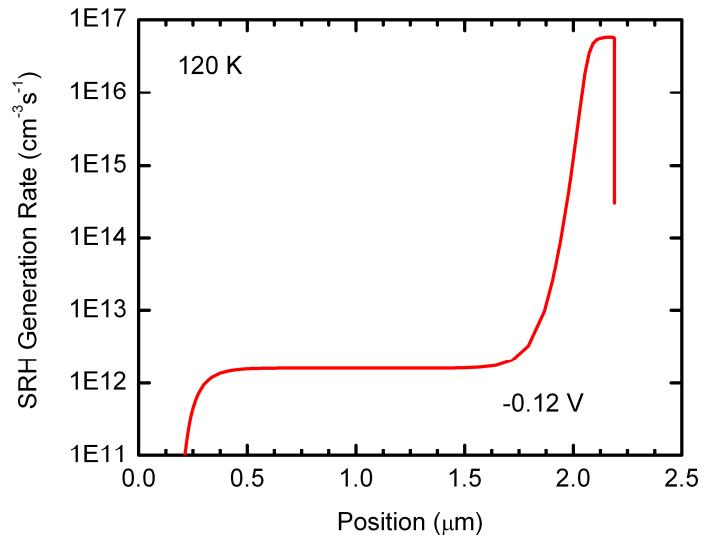
- Equal to maximum nBn responsivity

No “step” structure in I-V

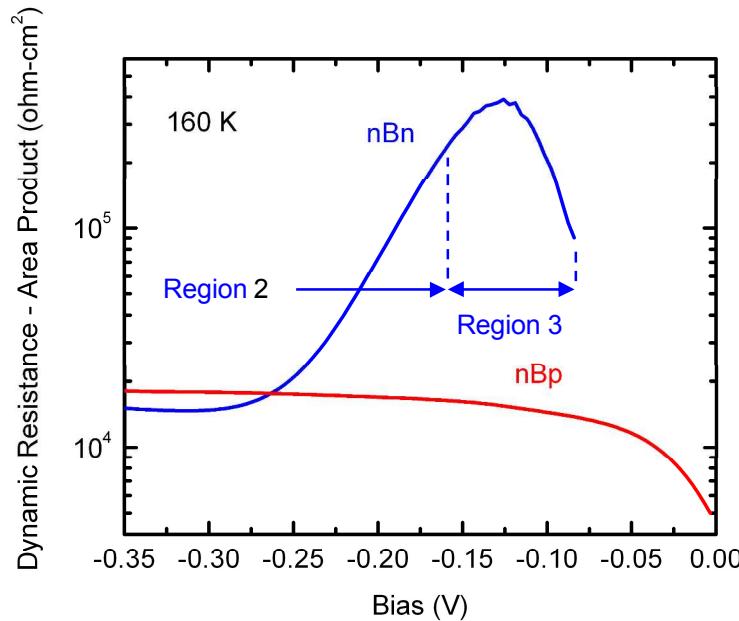
T dependence is $E_g/2kT$ – like at both biases

Depletion region SRH at -0.12 V similar to nBn at -0.35 V

Characteristics very similar to simulated homojunction p-n

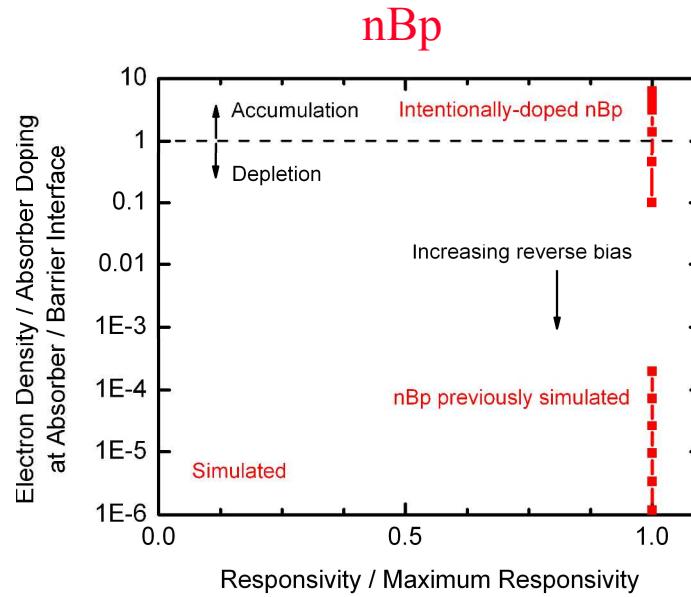
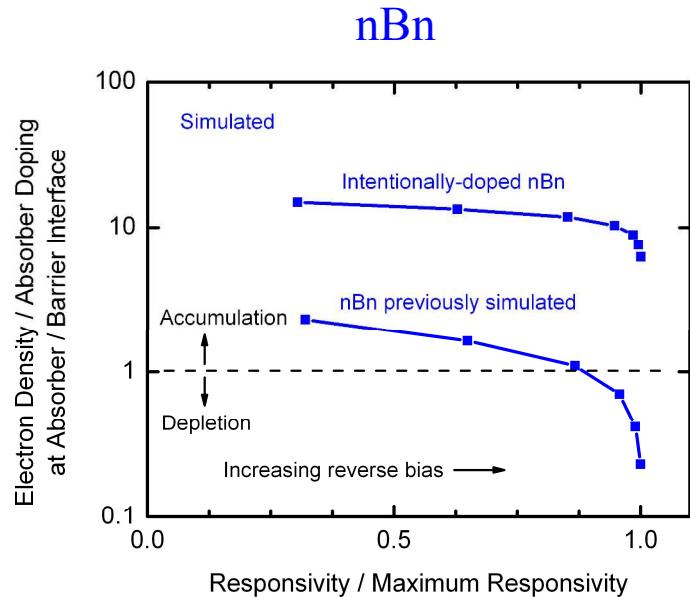


Comparison of simulated dynamic resistances



At best bias point nBn dynamic resistance is ~20x higher than nBp
High dynamic resistance of nBn obtained in Region 3 (diffusion-current-dominated)
Suggests that nBn is capable of having low Johnson noise

Can high responsivity be achieved with *no absorber depletion*?



- With proper doping, high responsivity is possible in both nBn and nBp with no depletion
- Differential resistance of doped nBp comparable to nBn

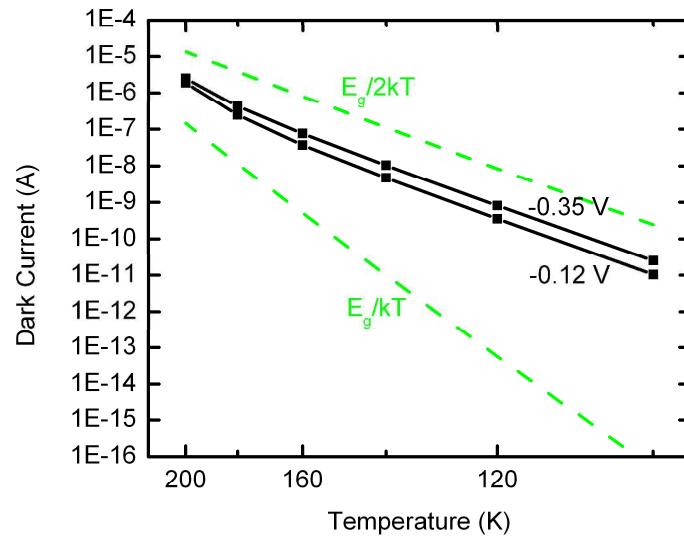
→ **Performance of optimized nBp should be similar to optimized nBn**



Conclusions

- nBp structure is more generally applicable than nBn
- nBn and nBp mid-wave detectors fabricated with dark currents dominated by intrinsic sources (not sidewall leakage)
- Experimental characteristics of nBn and nBp qualitatively different
 - nBn exhibits bias region where diffusion current dominates at low T
 - nBp dark current dominated by depletion region SRH
- Simulation confirms observed behavior in both devices
- Characteristics of unoptimized nBp similar to convention p-n detector
- Differences in characteristics explained by larger nBp built-in potential
- Optimized nBn and nBp should have similar performance
 - Absence of parasitic sidewall conductance
 - Dark current dominated by absorber diffusion current

Simulated n-p homojunction dark current



Characteristics very similar to nBp – depletion region SRH dominates